

NOT RECOMMENDED FOR NEW DESIGN

The EY1601SA-ADJ is a high voltage, low quiescent current linear regulator ideally suited for “always-on” and “keep alive” automotive applications. The EY1601SA-ADJ operates from an input voltage of +6V to +40V under normal operating conditions and operates down to +3V under a cold crank. It consumes only 18μA of quiescent current at no load on the adjustable version.

The EY1601SA-ADJ is available in adjustable output voltage (2.5V to 12V). It features an EN pin that can be used to put the device into a low-quiescent current shutdown mode where it draws only 1.8μA of supply current. The device features over-temperature shutdown and current limit protection.

The EY1601SA-ADJ is AEC-Q100 qualified. It is rated over the -40°C to +125°C automotive temperature range and is available in an 8 Ld EPSONC with exposed pad package.

Applications

- Automotive
- Industrial
- Telecom

Features

- Optimized for “Always-on” Automotive Applications
- 18μA Typical Quiescent Current
- Guaranteed 50mA Output Current
- Operates through Cold Crank Down to 3V
- 40V Tolerant Logic Level (TTL/CMOS) Enable Input
- 1.8μA of Typical Shutdown Current
- Low Dropout Voltage of 120mV at 50mA
- Adjustable Output Voltage
- Stable Operation with 10μF Output Capacitor
- Thermal Shutdown and Current Limit Protection
- -40°C to +125°C Operating Temperature Range
- Thermally Enhanced 8 Ld Exposed Pad SOIC Package
- AEC-Q100 Qualified
- 6kV ESD HBM Rated
- Pb-Free (RoHS Compliant)

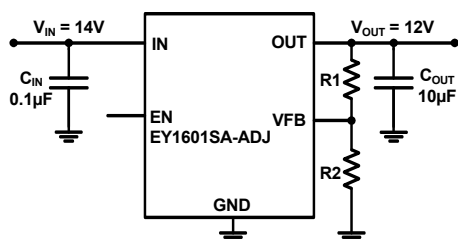


FIGURE 1. TYPICAL APPLICATION

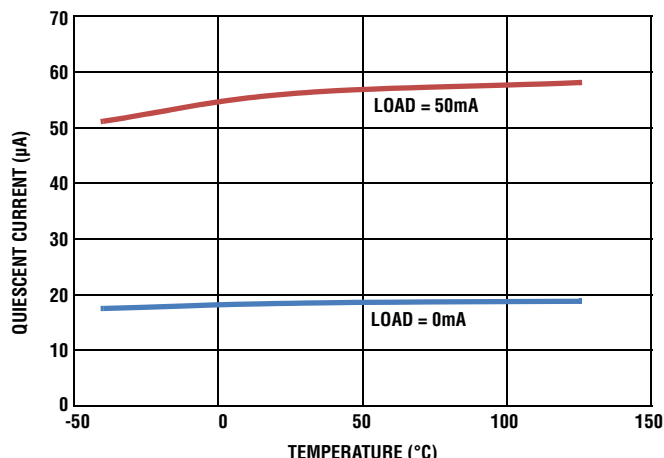


FIGURE 2. QUIESCENT CURRENT vs. LOAD CURRENT (AT UNITY GAIN). $V_{IN} = 14V$

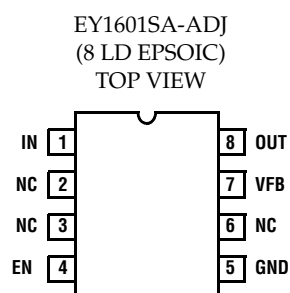
Ordering Information

PART NUMBER (Notes 1, 2)	PART MARKING	TEMP. RANGE (°C)	ENABLE PIN	OUTPUT VOLTAGE (V)	PACKAGE (Pb-Free)	PKG. DWG. #
EY1601SA-ADJ	Y1601A	-40 to +125	Yes	ADJ	8 Ld EPSOIC	M8.15B

NOTES:

1. Add “-T*” suffix for tape and reel. Please refer to Packing and Marking Information: www.altera.com/support/reliability/packing/rel-packing-and-marking.html
2. These Altera Enpirion Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Altera Enpirion Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

Pin Configuration



Pin Descriptions

PIN NUMBER	PIN NAME	DESCRIPTION
1	IN	Input voltage pin. A minimum 0.1 μ F X5R/X7R capacitor is required for proper operation.
2, 3, 6	NC	Pins have internal termination and can be left not connected. Connection to ground is optional.
4	EN	High on this pin enables the device.
5	GND	Ground pin.
7	VFB	In the adjustable output voltage option, this pin is connected to the external feedback resistor divider which sets the LDO output voltage.
8	OUT	Regulated output voltage. A 10 μ F X5R/X7R output capacitor is required for stability.
	EPAD	It is recommended to solder the EPAD to the ground plane.

Absolute Maximum Ratings

Supply Voltage, V_{IN} +45V
 IN pin to GND Voltage GND - 0.3V to V_{IN}
 OUT pin to GND Voltage GND - 0.3V to 16V
 EN pin to GND Voltage GND - 0.3V to V_{IN}
 Output Short-circuit Duration Indefinite
 ESD Rating
 Human Body Model (Tested per JESD22-A114E) 6kV
 Machine Model (Tested per JESD-A115-A) 350V
 Charge Device Model (Tested per JESD22-C101C) ... 2.2kV
 Latch Up (Tested per JESD78B; Class II, Level A) 100mA

Thermal Information

Thermal Resistance (Typical) θ_{JA} (°C/W) θ_{JC} (°C/W)
 8 Ld EPSON Package (Notes 3, 4) 50 9
 Maximum Junction Temperature +150°C
 Maximum Storage Temperature Range -65°C to +175°C

Recommended Operating Conditions

Ambient Temperature Range -40°C to +125°C
 IN pin to GND Voltage +3V to +40V
 OUT pin to GND Voltage +2.5V to +12V
 EN pin to GND Voltage 0V to +40V

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

NOTES:

- θ_{JA} is measured in free air with the component mounted on a high effective thermal conductivity test board with “direct attach” features.
- For θ_{JC} , the “case temp” location is the center of the exposed metal pad on the package underside.

Electrical Specifications Recommended Operating Conditions, unless otherwise noted. $V_{IN} = 14V$, $I_{OUT} = 1mA$, $C_{IN} = 0.1\mu F$, $C_{OUT} = 10\mu F$, $T_A = T_J = -40^\circ C$ to $+125^\circ C$, unless otherwise noted. Typical specifications are at $T_A = +25^\circ C$. **Boldface limits apply over the operating temperature range, -40°C to +125°C.**

PARAMETER	SYMBOL	TEST CONDITIONS	MIN (Note 7)	TYP	MAX (Note 7)	UNIT
Input Voltage Range	V_{IN}		6		40	V
		Cold Crank condition	3		40	V
Guaranteed Output Current	I_{OUT}	$V_{IN} = V_{OUT} + V_{DO}$	50			mA
Output Voltage	V_{OUT}	EN = High $V_{IN} = 14V$ $I_{OUT} = 0.1mA$	1.211	1.223	1.235	V
Line Regulation	$\Delta V_{OUT}/\Delta V_{IN}$	$3V \leq V_{IN} \leq 40V$ $I_{OUT} = 1mA$		0.04	0.115	%
Load Regulation	$\Delta V_{OUT}/\Delta I_{OUT}$	$V_{IN} = V_{OUT} + V_{DO}$ $I_{OUT} = 100\mu A$ to 50mA		0.25	0.5	%
Dropout Voltage (Note 5)	ΔV_{DO}	$I_{OUT} = 1mA$, $V_{OUT} = 3.3V$		10	38	mV
		$I_{OUT} = 50mA$, $V_{OUT} = 3.3V$		130	340	mV
		$I_{OUT} = 1mA$, $V_{OUT} = 5V$		10	48	mV
		$I_{OUT} = 50mA$, $V_{OUT} = 5V$		120	350	mV
Shutdown Current	I_{SHDN}	EN = LOW		1.8	3.64	μA
Quiescent Current	IQ	EN = High $V_{IN} = 14V$ $I_{OUT} = 0mA$, VFB Version, $V_{OUT} = V_{VFB}$		18	24	μA
		$I_{OUT} = 1mA$, VFB Version, $V_{OUT} = V_{VFB}$		22	42	μA
		$I_{OUT} = 10mA$, VFB Version, $V_{OUT} = V_{VFB}$		34	60	μA
		$I_{OUT} = 50mA$, VFB Version, $V_{OUT} = V_{VFB}$		56	82	μA
Power Supply Rejection Ratio	PSRR	$f = 100Hz$; $V_{in_ripple} = 500mV_{p-p}$; Load = 50mA		58		dB
EN FUNCTION						
EN Threshold Voltage	V_{EN_H}	$V_{OUT} = \text{Off to On}$			1.485	V
	V_{EN_L}	$V_{OUT} = \text{On to Off}$	0.935			V

Electrical Specifications Recommended Operating Conditions, unless otherwise noted. $V_{IN} = 14V$, $I_{OUT} = 1mA$, $C_{IN} = 0.1\mu F$, $C_{OUT} = 10\mu F$, $T_A = T_J = -40^\circ C$ to $+125^\circ C$, unless otherwise noted. Typical specifications are at $T_A = +25^\circ C$. **Boldface limits apply over the operating temperature range, $-40^\circ C$ to $+125^\circ C$.** (Continued)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN (Note 7)	TYP	MAX (Note 7)	UNIT
EN Pin Current	I_{EN}	$V_{OUT} = 0V$		0.026		μA
EN to Regulation Time (Note 6)	t_{EN}			1.65	1.93	ms
PROTECTION FEATURES						
Output Current Limit	I_{LIMIT}	$V_{OUT} = 0V$	60	118		mA
Thermal Shutdown	T_{SHDN}	Junction Temperature Rising		+165		$^\circ C$
Thermal Shutdown Hysteresis	T_{HYST}			+20		$^\circ C$

NOTES:

- Dropout voltage is defined as $(V_{IN} - V_{OUT})$ when V_{OUT} is 2% below the value of V_{OUT} when $V_{IN} = V_{OUT} + 3V$.
- Enable to Regulation is the time the output takes to reach 95% of its final value with $V_{IN} = 14V$ and EN is taken from V_{IL} to V_{IH} in 5ns. For the adjustable versions, the output voltage is set at 5V.
- Parameters with MIN and/or MAX limits are 100% tested at $+25^\circ C$, unless otherwise specified. Temperature limits established by characterization and are not production tested.

Typical Performance Curves $V_{IN} = 14V$, $I_{OUT} = 1mA$, $V_{OUT} = 5V$, $T_J = +25^\circ C$ unless otherwise specified.

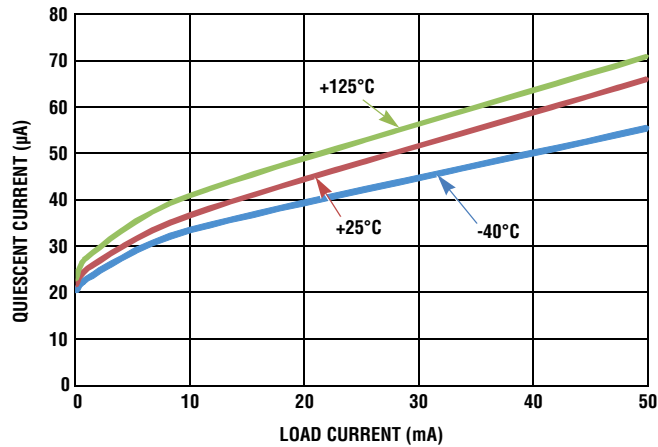


FIGURE 3. QUIESCENT CURRENT vs LOAD CURRENT

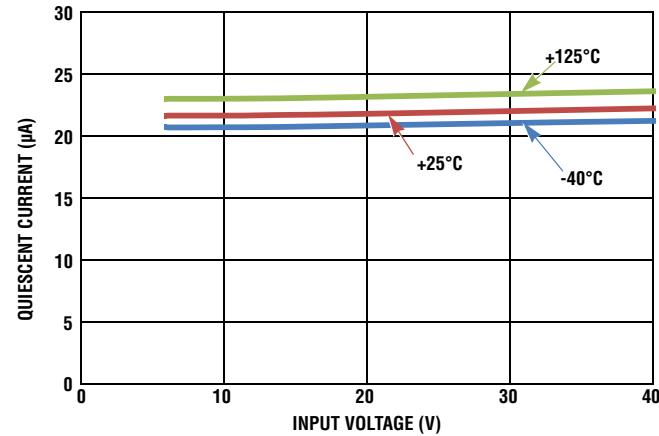


FIGURE 4. QUIESCENT CURRENT vs INPUT VOLTAGE (NO LOAD)

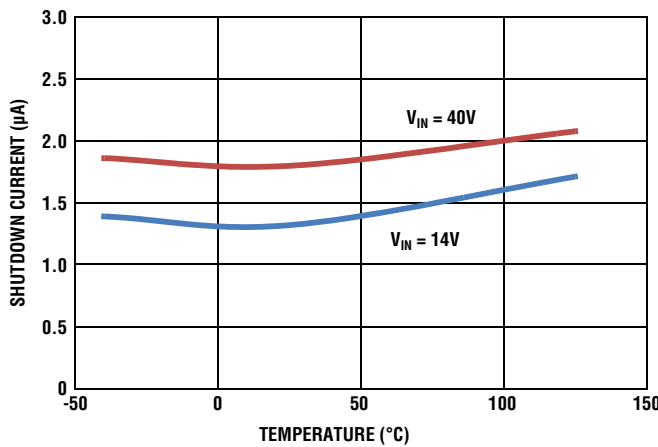


FIGURE 5. SHUTDOWN CURRENT vs TEMPERATURE (EN = 0)

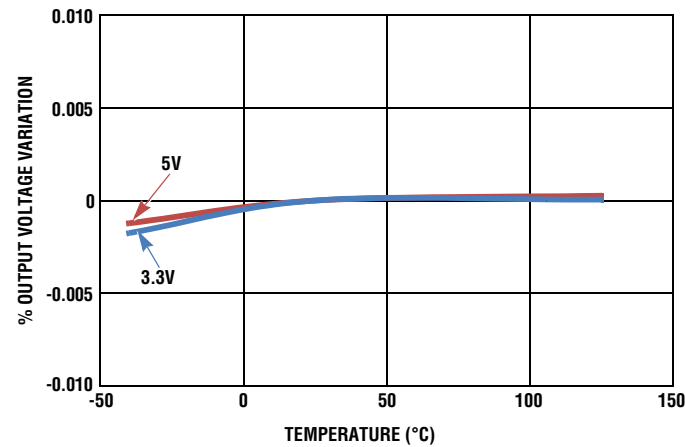


FIGURE 6. OUTPUT VOLTAGE vs TEMPERATURE (LOAD = 50mA)

Typical Performance Curves $V_{IN} = 14V$, $I_{OUT} = 1mA$, $V_{OUT} = 5V$, $T_J = +25^\circ C$ unless otherwise specified. (Continued)

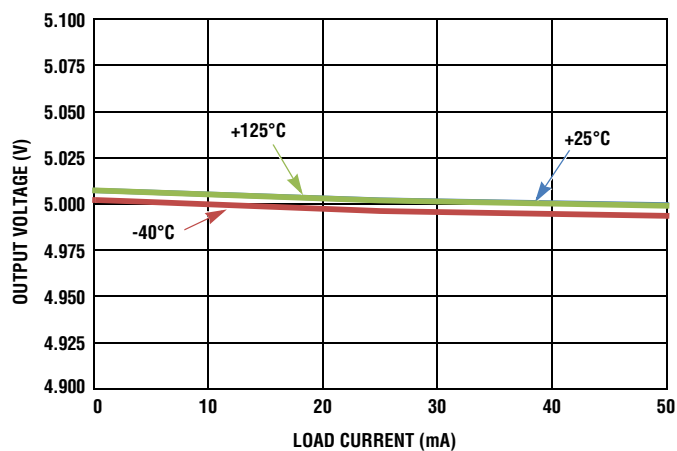


FIGURE 7. OUTPUT VOLTAGE vs LOAD CURRENT

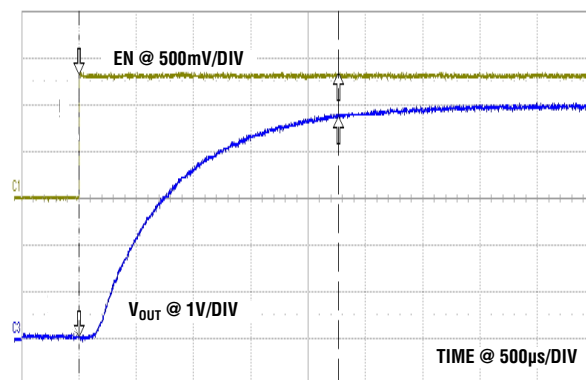


FIGURE 8. START-UP WAVEFORM

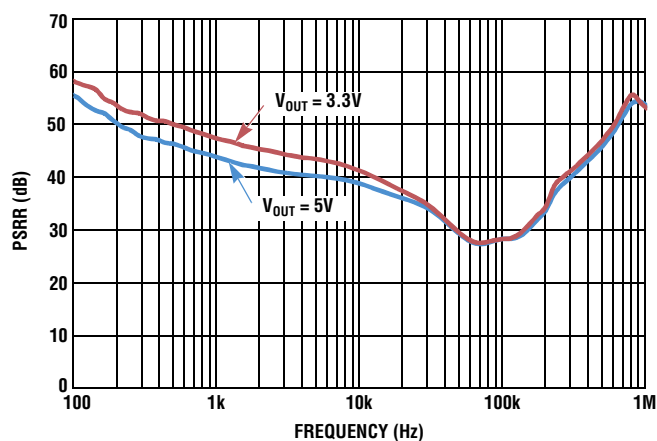


FIGURE 9. POWER SUPPLY REJECTION RATIO (LOAD = 50mA)

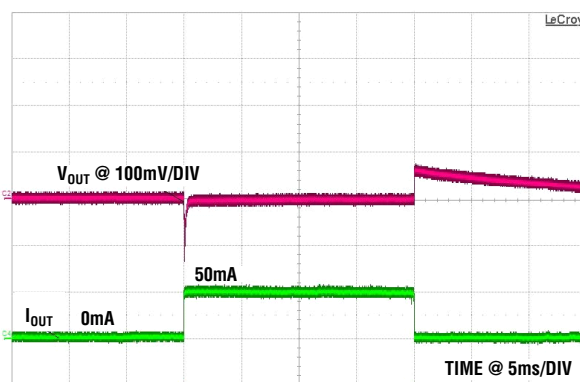
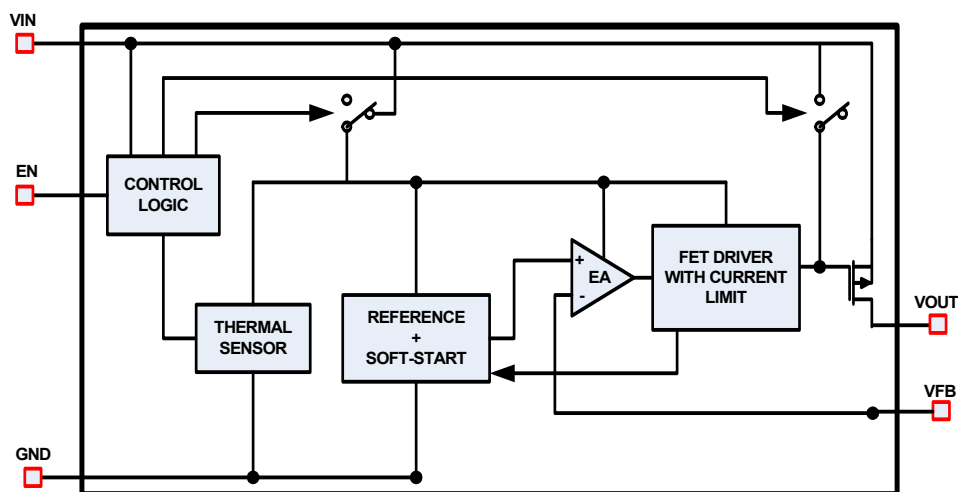


FIGURE 10. LOAD TRANSIENT RESPONSE

Block Diagram



Functional Description

Functional Overview

The EY1601SA-ADJ is a high performance, high voltage, low-dropout regulator (LDO) with 50mA sourcing capability. The part is qualified to operate over the -40°C to $+125^{\circ}\text{C}$ automotive temperature range. Featuring ultra-low quiescent current, it makes an ideal choice for “always-on” automotive applications. It works well under a “load dump condition” where the input voltage could rise up to 40V. The LDO continues to operate down to 3V under a “cold-crank” condition. The device also features current limit and thermal shutdown protection.

Enable Control

The EY1601SA-ADJ features an enable pin. When it is pulled low, the IC goes to a shutdown mode. In this condition, the device draws less than $2\mu\text{A}$. Driving the pin high turns the device on.

Current Limit Protection

The EY1601SA-ADJ has internal current limit functionality to protect the regulator during fault conditions. During current limit, the output sources a fixed amount of current largely independent of the output voltage. If the short or overload is removed from V_{OUT} , the output returns to normal voltage regulation mode.

Thermal Fault Protection

In the event the die temperature exceeds typically $+165^{\circ}\text{C}$, the output of the LDO will shut down until the die temperature cools down to typically $+145^{\circ}\text{C}$. The level of power dissipated, combined with the ambient temperature and the thermal impedance of the package, will determine if the junction temperature exceeds the thermal shutdown temperature. Also see the section on “Power Dissipation”.

Application Information

Input and Output Capacitors

For the output, a ceramic capacitor (X5R or X7R) with a capacitance of $10\mu\text{F}$ is recommended for the EY1601SA-ADJ to maintain stability. The ground connection of the output capacitor should be routed directly to the GND pin of the device and also placed close to the IC. A minimum of $0.1\mu\text{F}$ (X5R or X7R) is recommended at the input.

Output Voltage Setting

For the adjustable version of the EY1601SA-ADJ, the output voltage is programmed using an external resistor divider as shown in Figure 11.

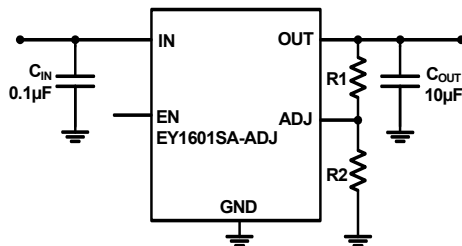


FIGURE 11. ADJUSTABLE VERSION

The output voltage is calculated using Equation 1:

$$V_{OUT} = 1.223V \times \left(\frac{R_1}{R_2} + 1 \right) \quad (\text{EQ. 1})$$

Power Dissipation

The junction temperature must not exceed the range specified in “Recommended Operating Conditions” on page 3. The power dissipation can be calculated using Equation 2:

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} + V_{IN} \times I_{GND} \quad (\text{EQ. 2})$$

The maximum allowable junction temperature, $T_{J(MAX)}$ and the maximum expected ambient temperature, $T_{A(MAX)}$ will determine the maximum allowable junction temperature rise (ΔT_J), as shown in Equation 3:

$$\Delta T_J = T_{J(MAX)} - T_{A(MAX)} \quad (\text{EQ. 3})$$

To calculate the maximum ambient operating temperature, use the junction-to-ambient thermal resistance (θ_{JA}) as shown in Equation 4:

$$T_{J(MAX)} = P_{D(MAX)} \times \theta_{JA} + T_A \quad (\text{EQ. 4})$$

Board Layout Recommendations

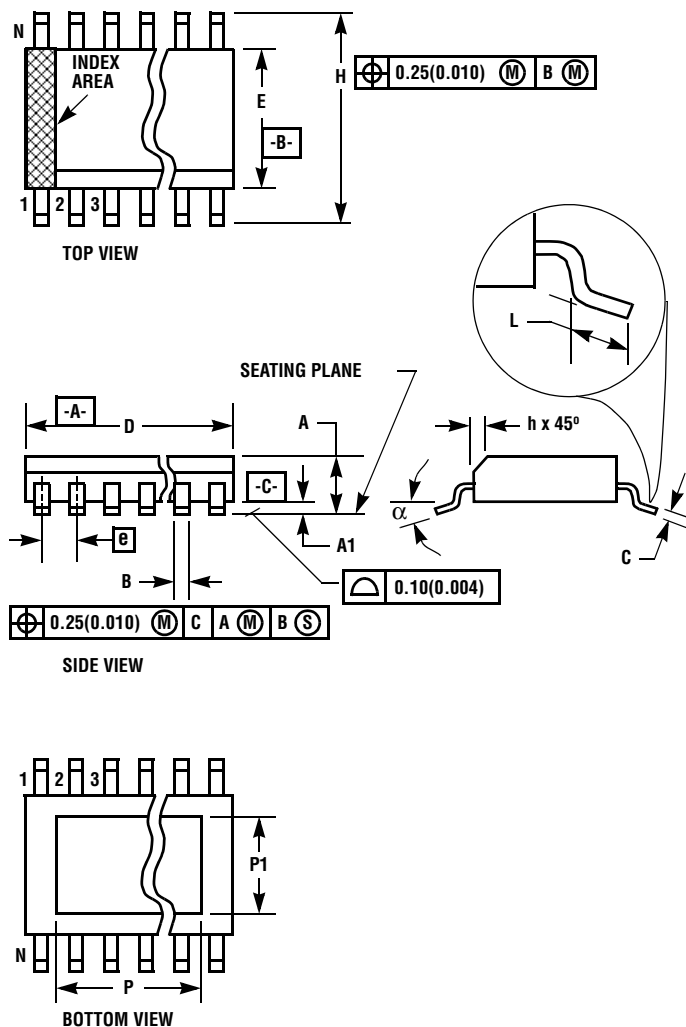
A good PCB layout is important to achieve expected performance. Consideration should be taken when placing the components and routing the trace to minimize the ground impedance, and keep the parasitic inductance low. The input and output capacitors should have a good ground connection and be placed as close to the IC as possible. The feedback trace in the adjustable version should be away from other noisy traces. Connect EPAD to the ground plane for better heat dissipation. Thermal vias on the EPAD increase heat dissipation.

Revision History

The table lists the revision history for this document.

DATE	REVISION	CHANGE
May, 2014	A	Initial Release.
June, 2019	B	Added NRND.

Small Outline Exposed Pad Plastic Packages (EPSOIC)



M8.15B

8 LEAD NARROW BODY SMALL OUTLINE EXPOSED PAD PLASTIC PACKAGE

SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	0.056	0.066	1.43	1.68	-
A1	0.001	0.005	0.03	0.13	-
B	0.0138	0.0192	0.35	0.49	9
C	0.0075	0.0098	0.19	0.25	-
D	0.189	0.196	4.80	4.98	3
E	0.150	0.157	3.81	3.99	4
e	0.050 BSC		1.27 BSC		-
H	0.230	0.244	5.84	6.20	-
h	0.010	0.016	0.25	0.41	5
L	0.016	0.035	0.41	0.89	6
N	8		8		7
a	0°	8°	0°	8°	-
P	-	0.094	-	2.387	11
P1	-	0.094	-	2.387	11

Rev. 5 8/10

NOTES:

1. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
3. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
4. Dimension "E" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25mm (0.010 inch) per side.
5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
6. "L" is the length of terminal for soldering to a substrate.
7. "N" is the number of terminal positions.
8. Terminal numbers are shown for reference only.
9. The lead width "B", as measured 0.36mm (0.014 inch) or greater above the seating plane, shall not exceed a maximum value of 0.61mm (0.024 inch).
10. Controlling dimension: INCH. Converted millimeter dimensions are not necessarily exact.
11. Dimensions "P" and "P1" are thermal and/or electrical enhanced variations. Values shown are maximum size of exposed pad within lead count and body size.

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